Monolithic Integrated Circuit

Description

The integrated circuit TDA 1083 includes, with exception of the FM front end, a complete AM–/FM–radio–circuit with audio power amplifier. An internal Z–diode stabilizes

the supply voltage at $V_S \approx 13V$, which allows with the aid of a resistor and a rectifier, the circuit to be driven by a higher external supply voltage.

Applications: AM–/FM– and Audio–Amplifier

Features

- Large supply voltage range V_S=3 ... 12V
- High AM–Sensitivity
- Limiting threshold voltage $V_i=50 \ \mu V$

- Audio output power $P_0 = 0.7 \text{ W}$
- AFC-connection for VHF-Tuner
- AM–FM switching without high frequency voltages

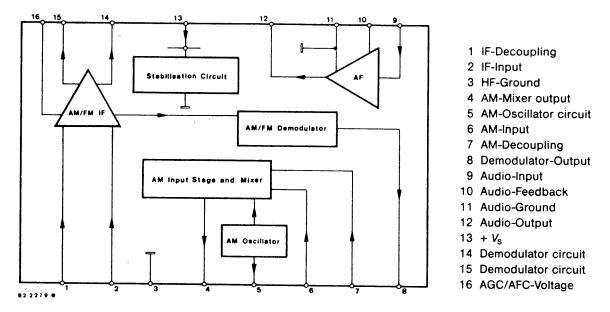


Figure 1 Block diagram and pin connections

Absolute Maximum Ratings

Reference points Pin 3 and 11, unless otherwise specified

Parameters	Symbol	Value	Unit
Supply voltage range Pin 13	Vs	3 12	V
Supply current when using the integrated stabilisation			
circuit, V _S =12.5 to 14.3V Pin 13	IS	50	mA
Power dissipation T _{amb} =65 °C	P _{tot}	600	mW
Junction temperature	Tj	125	°C
Storage temperature range	T _{stg}	-25 +125	°C

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Thermal Resistance

Parameters	Symbol	Maximum	Unit
Junction ambient	R _{thJA}	100	K/W

Electrical Characteristics

 $V_{s=}$ 9 V, reference points Pin 3 and 11, $T_{amb=}$ 25 °C, unless otherwise specified

Parameters	Test Conditions / Pin	Symbol	Min	Тур	Max	Unit
AF Amplifier						
AF voltage amplification	f= 1 kHz	Gv		40		dB
Input impedance		R _i		150		kΩ
Output power	Figure 4, 5 V _S =5.5V, R _L = 8Ω,= 10%	Po	300			mW
AM-IF Amplifier, f _i =1MHz, f _{II}	==455kHz, f _{mod} =1kHz, m=0	.3				
DC voltages at AM mode without signal at: $V_S=3V$	Pin 10 Pin 12 Pin 13 Pin 16	V _{10B} V _{12B} V _{13B} V _{16B}	1.0 3.0 1.25	1.2 3.0	1.4 3.0 2.0	V V V V
I _S =42 mA (V _S =12.514.3 V)	Pin 10 Pin 12 Pin 13 Pin 16	V _{10B} V _{12B} V _{13B} V _{16B}	5.9 12.5 1.5	1.2 13.3	7.2 14.3 2.0	V V V V
Regulation range for: $V_{oAF}/V_{oAF} = -10$ dB	Pin 6	ΔV_i		70		dB
AF voltage at demodulator output	Pin 8	V _{oAF}		100		mV
FM-IF Amplifier, f _{IF} =10.7 MH	$Iz, \Delta f = \pm 22,5 \text{ kHz}, f_{\text{mod}} = 1$	kHz				
DC voltages at FM mode without signal at: $V_S=3V$	Pin 10 Pin 12 Pin 13 Pin 16	$\begin{array}{c} V_{10B} \\ V_{12B} \\ V_{13B} \\ V_{16B} \end{array}$	1.0 3.0 1.8	1.2 3.0	1.4 3.0 2.8	V V V V
I _S =42 mA (V _S =12.514.3 V)	Pin 10 Pin 12 Pin 13 Pin 16	$\begin{array}{c} V_{10B} \\ V_{12B} \\ V_{13B} \\ V_{16B} \end{array}$	5.9 12.5 2.0	1.2 13.3	7.2 14.3 3.1	V V V V
Limiting threshold (-3 dB)	Pin 2	Vi		50		μV
AF voltage at demodulator output	Pin 8	V _{oAF}		100		mV

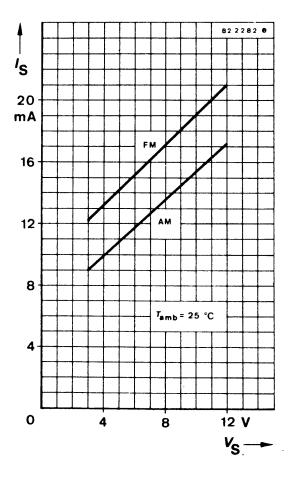
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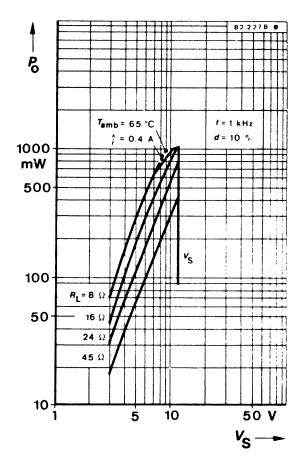
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Different dc voltages are developed at Pin 16 due to gain spread of AM–IF–amplifier. To determine the value of parallel resistance R_8 , at the output of the demodulator Pin 8 for $V_S = 9$ V, AM mode without signal, dc voltage should be selected at Pin 16.

Available in following voltage groups:

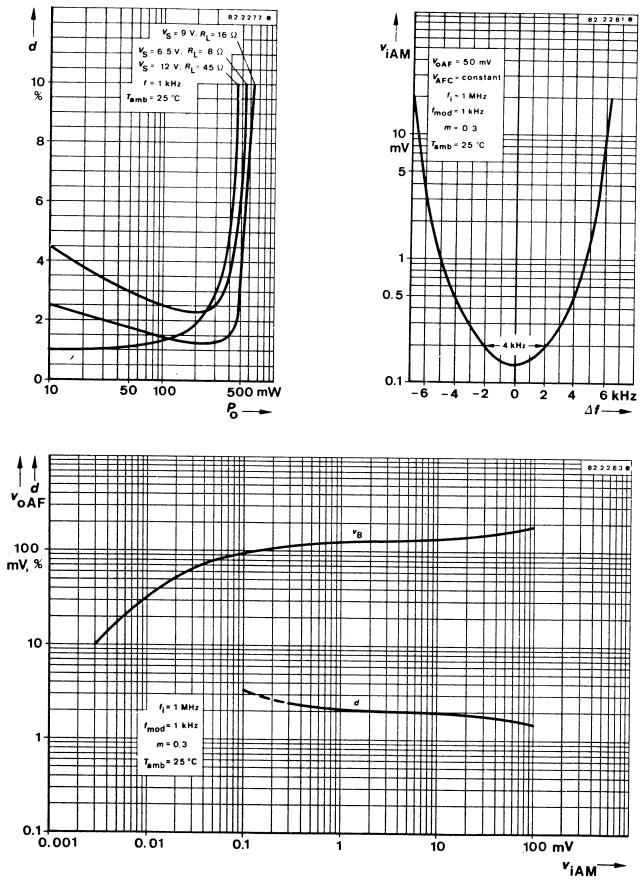
V ₁₆	1.4 1.7 V	1.7 1.9 V	1.9 2.1 V
R ₈	∞	47 kΩ	33 kΩ
Group	1	2	3





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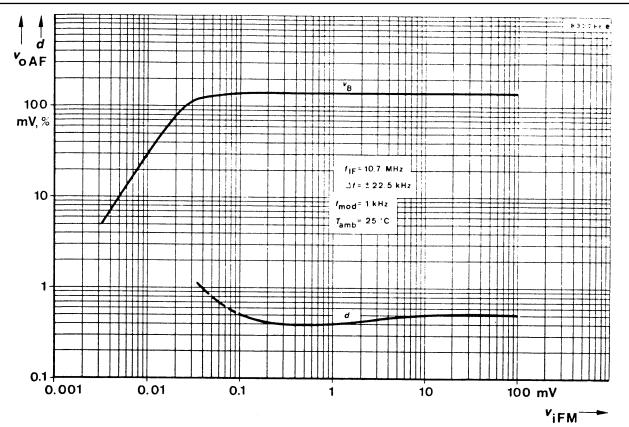
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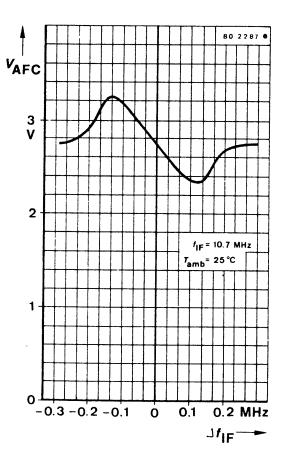
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Components in Figure 9

L ₁	=	4	Wdg \emptyset 0.45 CuL, Threaded core 7.5x3 material: Fi 01 U8 (Vogt GmbH)		
L ₂	=	5	Wdg Ø 0.45 CuL		
L ₃	=	5	Wdg \emptyset 0.45 CuL, air core \emptyset 3.5 mm		
L ₄	=	3+3	Wdg \emptyset 0.45 CuL, air core \emptyset 2.7 mm		
L ₅	=	12	Wdg Ø 0.25 CuL, Pin 3–1, Filter kit 154 AN(C) or 154ANS–7 A6363A0 (TOKO, Componex)		
L ₆	=	2	Wdg Ø 0.25 CuL, Pin 4–6		
L ₇	=	7	Wdg Ø 0.25 CuL, Pin 6–3, Filter kit 154AN(C) or 154EES–7 A6392FA (TOKO, Componex)		
L ₈	=	7	Wdg Ø 0.16 CuL, Pin 1–4, Filter kit 154AN(C) or 154EES–7 A6391ABM (TOKO, Componex)		
L9	=	5	Wdg Ø 0.16 CuL, Pin 2–6		
L ₁₀	=	96	Wdg Ø 0.25 CuLs, Ferrite aerial Ø 8x130 mm, Type 031039–2103–606, (Dra- loric)		
L ₁₁	=	6	Wdg Ø 0.25 CuLs		
L ₁₂	=	78	Wdg Ø 0.09 CuL, Pin 3–4, Filter kit RBR or RWOS–6A7609AAU (TOKO, Componex)		
L ₁₃	=	7	Wdg Ø 0.09 CuL, Pin 2–1		
L ₁₄	=	18	Wdg Ø 0.09 CuL, Pin 3–4, Filter kit RHN(C) or RHCS–1A7607AQH (TOKO, Componex)		
L ₁₅	=	46+100	Wdg Ø 0.09 CuL, Pin 6–2–1		
L ₁₆	=	72+72	Wdg Ø 0.09 Cul Pin 3–4/6–1, Filter kit RHN(C) or RHNS–1A7608AZP (TOKO, Componex)		
455 kHz	=	Ceramic	filter LBF 6 (Componex) or CFU 445 H (Stettner)		
10.7 MHz	=	Ceramic	Ceramic filter 10.7 MF-18 (Componex) or SFE 10.7 MA (Stettner)		
D_{r1}, D_{r3}	=	Ferrit be	Ferrit bead on the transistor terminal		
D _{r2}	=	16	Wdg \emptyset 0.25 CuL, \emptyset 2 air core		
D _{r4}	=	6	Wdg \emptyset 0.15 CuL, \emptyset 2.1x3 mm Ferrit bead		
C ₆ =C ₁₄	=	4.5 20	4.5 20 pF, Variable capacitor Type CY2–22124–RT02 (TOKO, Componex)		
C ₁₉	=	5 80 p	5 80 pF		
C ₂₁	=	5 140	5 140 pF		
R ₈	=	accordin	according to gain groups ∞ , 47 k Ω or 33 k Ω		

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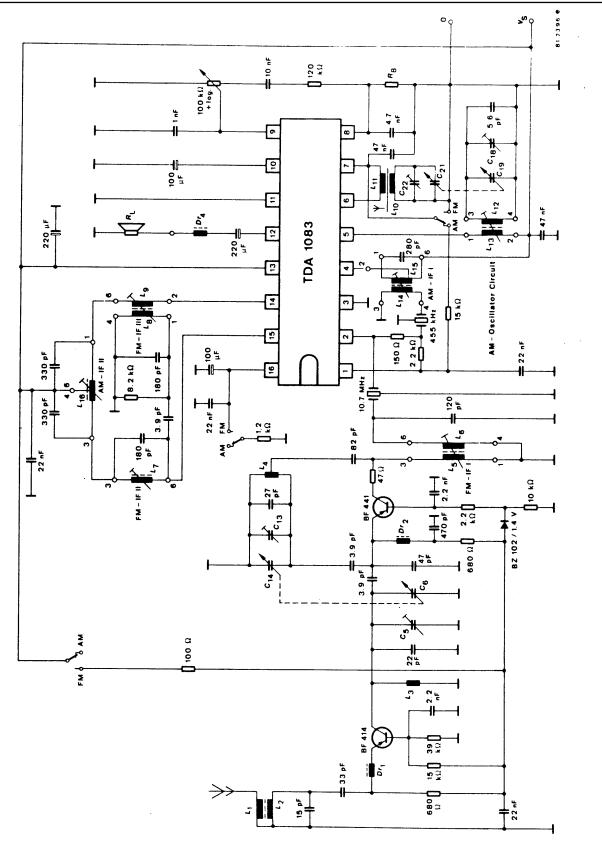


Figure 9 FM-/AM-receiver circuit

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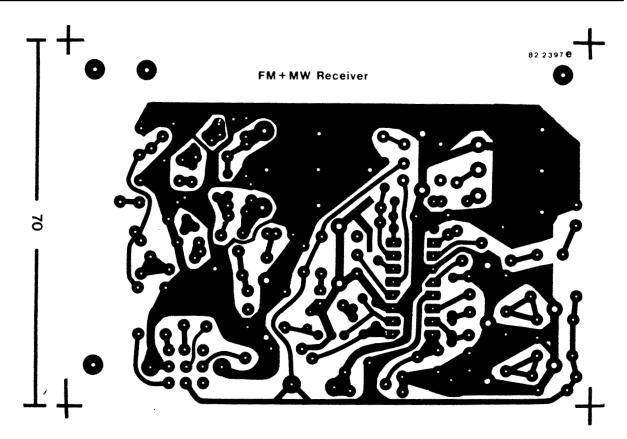


Figure 10 Layout of circuit board (soldered side) of the FM-/AM-receiver

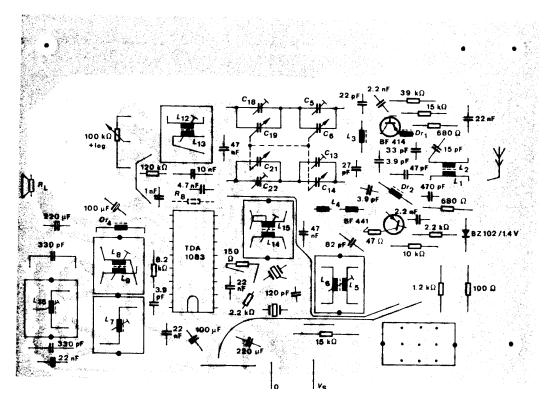
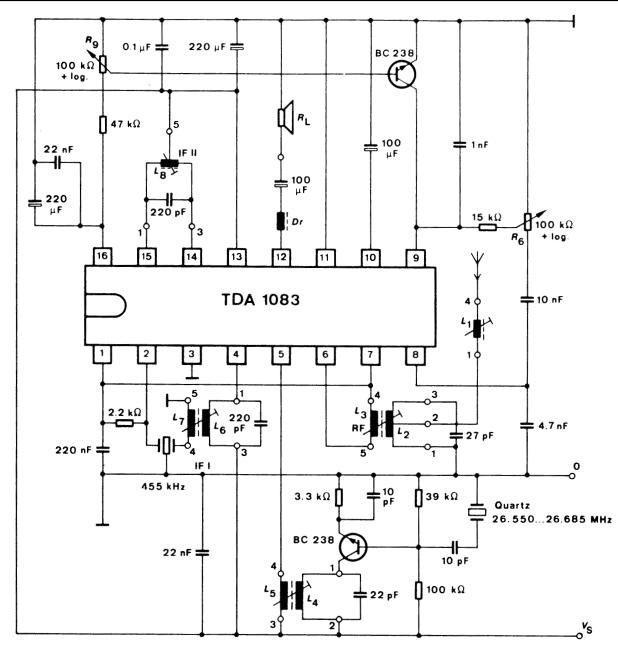


Figure 11 Printed board with components for FM–/AM–receiver



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Oscillator Circuit

82 2 2 8 5 .

L ₁	=	3	Wdg Ø 0.25 CuL Pin 3–4 (Neosid 7F1)
L ₂	=	3+4	Wdg Ø 0.25 CuL Pin 1−2−3 (Neosid 7F1)
L ₃	=	3	Wdg Ø 0.25 CuL Pin 4–5
L ₄	=	8	Wdg Ø 0.45 CuL Pin 1–2 (Neosid 7F1)
L ₅	=	1	Wdg Ø 0.25 CuL Pin 3–4
L ₆	=	154	Wdg Ø 0.08 CuL Pin 1–3 (Neosid 7A1)

L ₇	Ш	30	Wdg Ø 0.08 CuL Pin 4–5	
L ₈	II	76+76	Wdg Ø 0.08 CuL Pin 1−5−3 (Neosid 7A1)	
D _r	Ш	4	Wdg ∅ 0.25 CuL Ferrit bead	
455 kHz	II	Ceramic filter LFB 6 (Componex) or CFU 455 H (Stettner)		
R ₆	Ш	Volume control		
R9	Ш	Squelch		

Figure 12 27 MHz-receiver circuit

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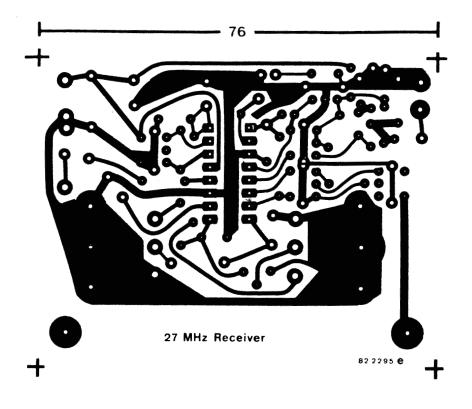


Figure 13 Layout of circuit board (soldered side) for 27 MHz-receiver

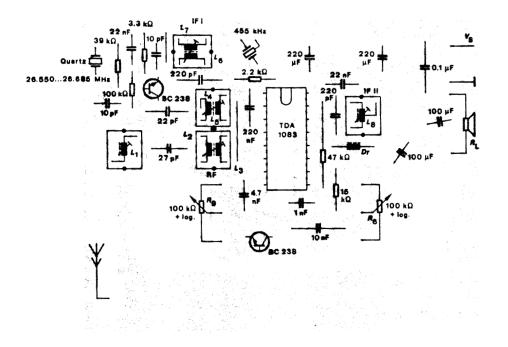
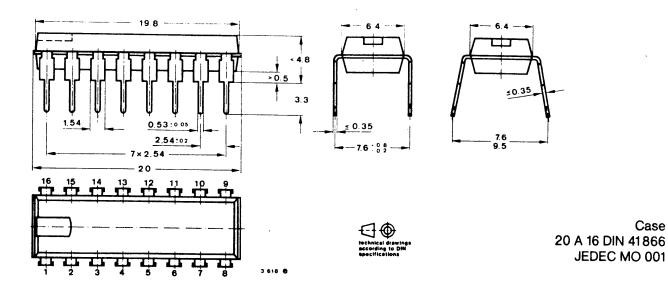


Figure 14 Printed board with components for 27 MHz–receiver **Preliminary Information**

Dimensions in mm



OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements and
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

Of particular concern is the control or elimination of releases into the atmosphere of those substances which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) will soon severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of any ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA and
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with and do not contain ozone depleting substances.

We reserve the right to make changes without further notice to improve technical design.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by customer. Should Buyer use TEMIC products for any unintended or unauthorized application, Buyer shall idemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

TEMIC TELEFUNKEN microelectronic GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax Number: 49 (0)7131 67 2423